

Schottky Diode Gen²

 $V_{RRM} = 150 V$

 $I_{FAV} = 2x \quad 60 \text{ A}$

 $V_F = 0.8 V$

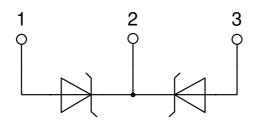
High Performance Schottky Diode Low Loss and Soft Recovery Common Cathode

Part number

DSA120C150QB



Backside: cathode



Features / Advantages:

- Very low Vf
- Extremely low switching losses
- Low Irm values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching

Applications:

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

Package: TO-3P

- Industry standard outline compatible with TO-247
- RoHS compliant
- Epoxy meets UL 94V-0

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Data according to IEC 60747and per semiconductor unless otherwise specified

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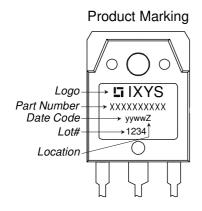


Schottky	•			ı	Ratings	S	
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V _{RSM}	max. non-repetitive reverse blocki	ing voltage	$T_{VJ} = 25^{\circ}C$			150	V
V _{RRM}	max. repetitive reverse blocking v	oltage	$T_{VJ} = 25^{\circ}C$			150	V
I _R	reverse current, drain current	$V_R = 150 \text{ V}$	$T_{VJ} = 25^{\circ}C$			900	μΑ
		$V_R = 150 \text{ V}$	$T_{VJ} = 125$ °C			5	mΑ
V _F	forward voltage drop	I _F = 60 A	$T_{VJ} = 25^{\circ}C$			0.93	٧
		$I_F = 120 A$				1.13	٧
		$I_F = 60 \text{ A}$	T _{VJ} = 125°C			0.80	٧
		$I_F = 120 \text{ A}$				1.03	٧
I _{FAV}	average forward current	T _C = 150°C	T _{vJ} = 175°C			60	Α
		rectangular $d = 0.5$					
V _{F0}	threshold voltage		T _{vJ} = 175°C			0.51	٧
r _F	slope resistance } for power lo	oss calculation only				3.9	mΩ
R _{thJC}	thermal resistance junction to cas	e				0.4	K/W
R _{thCH}	thermal resistance case to heatsing	nk			0.3		K/W
P _{tot}	total power dissipation		$T_C = 25^{\circ}C$			375	W
I _{FSM}	max. forward surge current	$t = 10 \text{ ms}$; (50 Hz), sine; $V_R = 0 \text{ V}$	$T_{VJ} = 45^{\circ}C$			1.20	kA
CJ	junction capacitance	$V_R = 24 V f = 1 MHz$	$T_{VJ} = 25^{\circ}C$		481		рF





Package	Package TO-3P			Ratings				
Symbol	Definition	Conditions	min.	typ.	max.	Unit		
I _{RMS}	RMS current	per terminal 1)			70	Α		
T _{VJ}	virtual junction temperature		-55		175	°C		
T _{op}	operation temperature		-55		150	°C		
T _{stg}	storage temperature		-55		150	°C		
Weight				5		g		
M _D	mounting torque		0.8		1.2	Nm		
F _c	mounting force with clip		20		120	N		



Part description

D = Diode

S = Schottky Diode

A = low VF

120 = Current Rating [A]

C = Common Cathode

150 = Reverse Voltage [V]

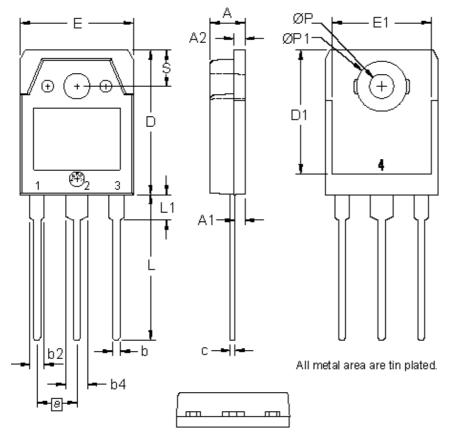
QB = TO-3P(3)

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DSA120C150QB	DSA120C150QB	Tube	30	501788
			Tube		

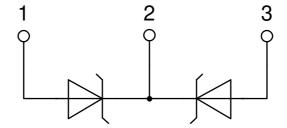
Equivalent Circuits for Simulation			* on die level	$T_{VJ} = 175^{\circ}C$
$I \rightarrow V_0$	$ R_0$ $-$	Schottky		
V _{0 max}	threshold voltage	0.51		V
$R_{0 \text{ max}}$	slope resistance *	1.3		$m\Omega$



Outlines TO-3P



Dim.	Millimeter		Inches		
DIM.	min	max	min	max	
Α	4.70	4.90	0.185	0.193	
A1	1.30	1.50	0.051	0.059	
A2	1.45	1.65	0.057	0.065	
b	0.90	1.15	0.035	0.045	
b2	1.90	2.20	0.075	0.087	
b4	2.90	3.20	0.114	0.126	
С	0.55	0.80	0.022	0.031	
D	19.80	20.10	0.780	0.791	
D1	16.90	17.20	0.665	0.677	
Е	15.50	15.80	0.610	0.622	
E1	13.50	13.70	0.531	0.539	
е	5.45 BSC		0.215 BSC		
L	19.80	20.20	0.780	0.795	
L1	3.40	3.60	0.134	0.142	
ØР	3.20	3.40	0.126	0.134	
ØP1	6.90	7.10	0.272	0.280	
S	4.90	5.10	0.193	0.201	





Schottky

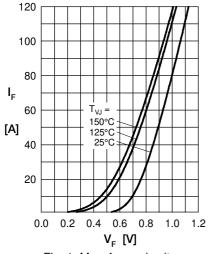


Fig. 1 Max. forward voltage drop characteristics

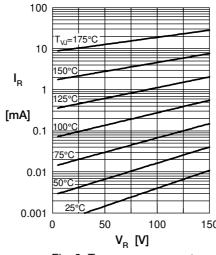


Fig. 2 Typ. reverse current I_R vs. reverse voltage V_R

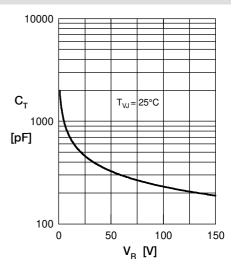


Fig. 3 Typ. junction capacitance C_T vs. reverse voltage V_R

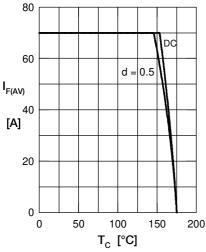


Fig. 4 Average forward current $I_{F(AV)}$ vs. case temp T_C

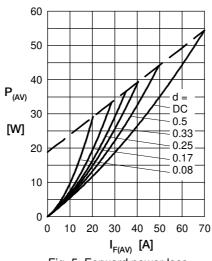


Fig. 5 Forward power loss characteristics

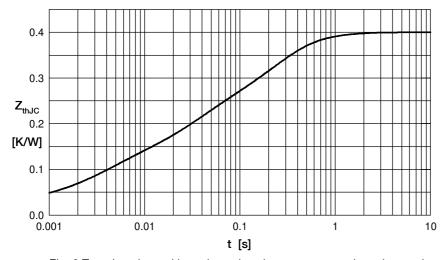


Fig. 6 Transient thermal impedance junction to case at various duty cycles

R_{thi} t_i
0.022 0.0002
0.082 0.0032
0.104 0.026
0.165 0.208
0.027 0.79

Note: All curves are per diode

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单击下面可查看定价,库存,交付和生命周期等信息

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